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LAPIS Technology Co., Ltd.
October 1, 2020

ML62Q1577 Reference Board User's Manual

Issue Date: January 19, 2018

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Preface

This manual describes about the ML62Q1577 Reference Board : RB-D62Q1577TB100.

Refer to following documents when necessary.

- ML62Q1500 Group User's Manual
Describes about the microcontroller ML62Q1500 Group.
- EASE1000 User's Manual
Describes about the On-chip emulator EASE1000.

1. Overview

1.1. Features

ML62Q1577 Reference Board is for learning how to use the ML62Q1577, on which adding external user components if necessary. Using ML62Q1577 Reference Board with LAPIS Semiconductor's on-chip emulator EASE1000 delivered with the software development environments, help user's software development and debugging and programming the Flash.

1.1.1. ML62Q1577 Reference Board features

- The board delivered with ML62Q1577 100pin TQFP .
- The connector linked to EASE1000 is mounted.
- Through-holes for connecting the pins of LSI to external peripheral boards.
- The power supply is selectable, supplied from the on-chip emulator EASE1000 or CN1_3pin / CN2_2pin.
- LED is mounted (P20, P21, P22)
- Crystal is mounted (32.768kHz)

1.1.2. ML62Q1577 Reference Board Hardware specifications

The hardware specification of ML62Q1577 Reference Board is indicated to Table 1.

Table 1 ML62Q1577 Reference Board Hardware specifications

Mounted LSI	U1 : ML62Q1577 100pin TQFP
Other Mounted components	PWR: Jumper for selecting the power supply input (3pin pin-header and short pin)
	J1: Jumper for selecting RESET_N pin (3pin pin-header and short pin)
	J2: Jumper for selecting P00/TEST0 pin (3pin pin-header and short pin)
	P20-P22: LEDs
	R1-R3: Resistors for LEDs by P20 to P22
	J3-J5: Jumper Chip for connecting LEDs
	X1, C3, C4: Crystal Oscillator (32.768kHz) and capacitors
	J8-J12: Jumper Chip for P75-P71
	CNE: Connector for EASE1000 (14pin connector)
	C1, C2, C9: Capacitors for VDD and VDDL
R4: Pull-up resistor for RESET_N	
Pads (or/and) Through holes for mounting components	CN1-CN2: Connectors for user application system (25pin, 2.54mm pitch, ϕ 0.8mm)
Power check pin	VDD, VSS, UVDD: ϕ 0.8mm
Operating voltage	+1.6V to +5.5V (Rise the VDD up to 1.8V or higher at the power up.)
Board size	55.88 mm x 93.98 mm

See the schematic for more detail about connection of the mounted components.

1.2. ML62Q1577 Reference Board Outline Drawing

Fig. 1 show the ML62Q1577 Reference Board.

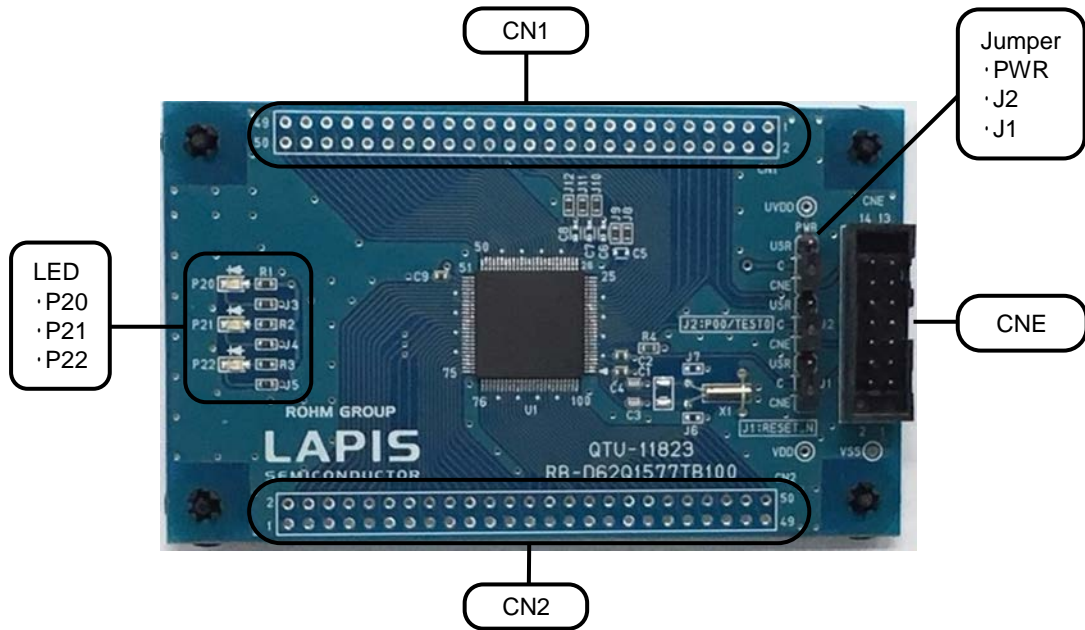


Fig. 1 ML62Q1577 Reference Board Outline Drawing

2. Function of ML62Q1577 Reference Board

2.1. Power Circuit

V_{DD} can select the input from 3.3VOUT of EASE1000 or CN1_3pin / CN2_2pin by PWR jumper.

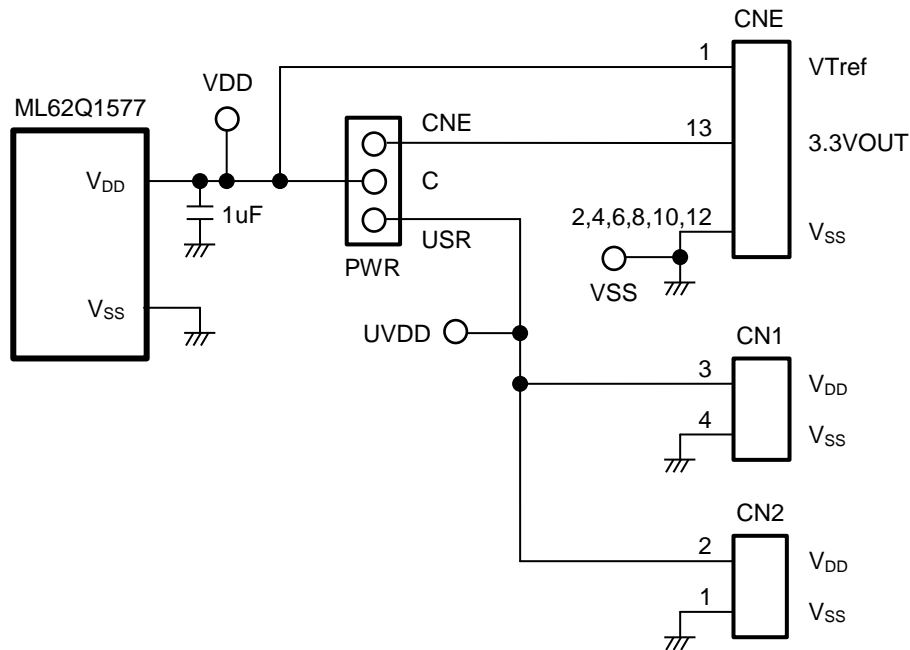


Fig. 2 Power Circuit

[Note]

The power supply ON/OFF procedure in case of setting PWR jumper to the USR-side, and using EASE1000.

- The procedure of power supply ON
 1. The USB cable of EASE1000 is connected.
 2. The power supply of user target system is turned on.
- The procedure of power supply OFF
 1. The power supply of user target system is turned off
 2. The .USB cable of EASE1000 is removed

2.2. Connector for EASE1000 (CNE)

EASE1000 can be used if J1 and J2 jumper are set to “CNE”.

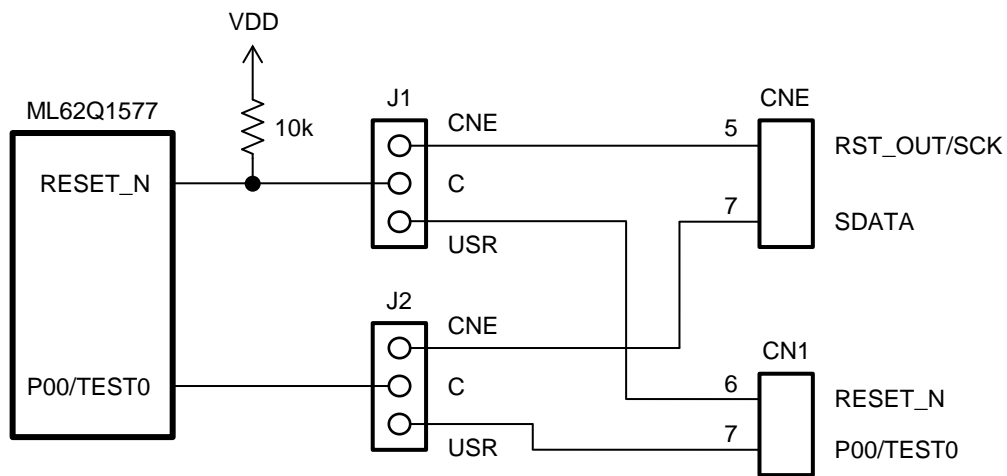


Fig. 3 EASE1000 Interface

[Note]

P00/TEST0 pin:

P00/TEST0 pin of ML62Q1577 is initially set as the pulled-up input mode.

When using EASE1000 do not set it as an output mode by the application program, otherwise EASE1000 cannot communicate with the ML62Q1577.

2.3. LED (P20, P21, P22)

P20-P22 of the ML62Q1577 are ports that can directly drive a LED. The Ports are connected to the LEDs through jumper-chip. Remove the jumper-chip when not using the LEDs.

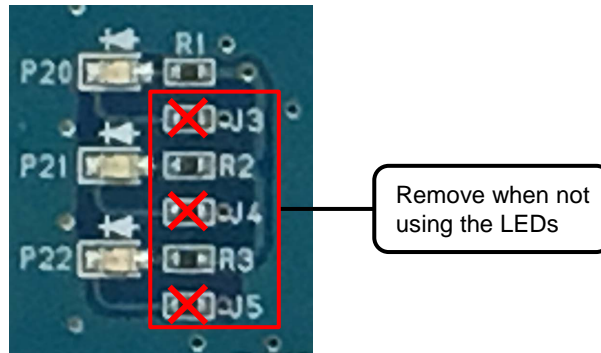


Fig. 4 Jumper-chip removal of LEDs

2.4. XT0/PIO0 , XT1/PIO1

ML62Q1577 Reference Borad can mount cylinder type or SMD type crystal oscillator.

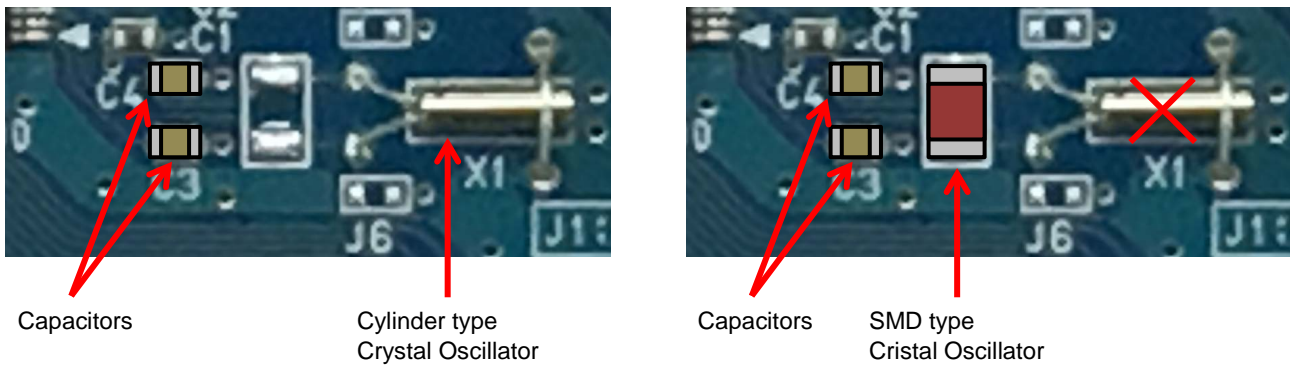


Fig. 5 Example of processing of Crystal Oscillator

2.5. P75, P74, P73, P72, P71

P75 to P71 are connected with CN1 using jumper chip.
 ML62Q1577 Reference Board can not use C5, C6, C7 and C8.
 Therefore please do not mount various parts on C5, C6, C7 and C8.

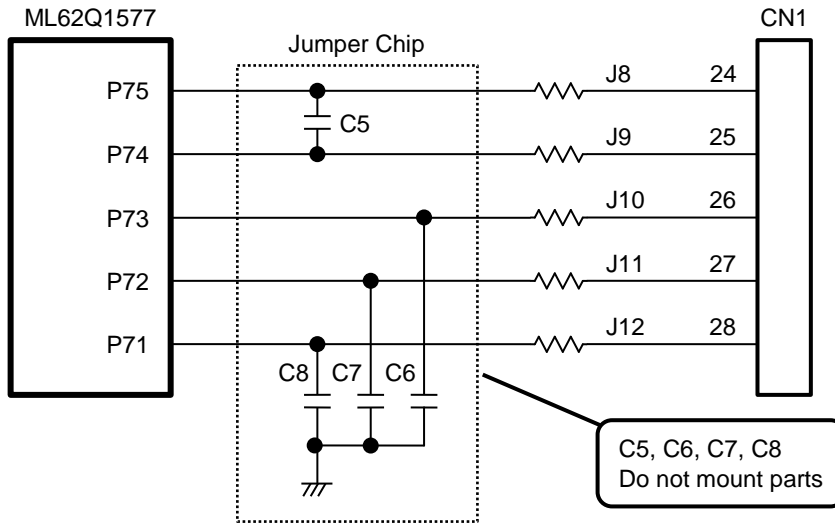


Fig. 6 P75 - P71 Circuit

3. User Interface

Table 2 show the pin list of the ML62Q1577 Reference Board user interface connector CN1 and CN2.

Table 2 ML62Q1577 Reference Board CN1/CN2

CN1	NAME	CN1	NAME	CN2	NAME	CN2	NAME
1	XT0/PIO0	26	P73	1	V _{SS}	26	PB0
2	XT1/PIO1	27	P72	2	V _{DD}	27	PB1
3	V _{DD}	28	P71	3	PA1	28	PB2
4	V _{SS}	29	P70	4	PA2	29	PB3
5	N.C.	30	P04	5	P54	30	PB4
6	RESET_N	31	P05	6	P55	31	PB5
7	P00/TEST0	32	P06	7	P14	32	P40
8	P01	33	P07	8	P15	33	P41
9	P80	34	P10	9	P16	34	P30
10	P81	35	P11	10	P17	35	P31
11	P82	36	P12	11	P20	36	P32
12	P83	37	P13	12	P21	37	P33
13	P84	38	P50	13	P22	38	P60
14	P85	39	P51	14	P23	39	P61
15	P86	40	P52	15	P24	40	P62
16	P87	41	P53	16	P25	41	P63
17	P44	42	P90	17	P26	42	P64
18	P45	43	P91	18	P27	43	P65
19	P02	44	P92	19	P56	44	P66
20	P03	45	P93	20	P57	45	P67
21	P46	46	P94	21	PA3	46	P42
22	P47	47	P95	22	PA4	47	PB6
23	P76	48	P96	23	PA5	48	PB7
24	P75	49	P97	24	PA6	49	P77
25	P74	50	PA0	25	PA7	50	P43

N.C. : Non-Connection

4. Precaution for use

- (1) The ML62Q1577 Reference Board is an unfinished product and intended for research and development and for expert use in the research and development facility only. The ML62Q1577 Reference Board is not intended for use for volume production or parts thereof.
- (2) Since the content specified herein is subject to change for improvement without notice, confirm the content is the latest when using the board.
- (3) See another documents ML62Q1500 group user's manual and EASE1000 user's manual when using the ML62Q1577 Reference Board.
- (4) Confirm the final electrical characteristics by using the mass production parts on your mass production boards.
- (5) LAPIS support replacing the board for an initial failure soon after the shipment, can not support repairing the board.
- (6) ML62Q1577 Reference Board have signal patterns on the underside, it might work in abnormal if using on conductive materials. Use it on insulating materials or having any preventable parts.

5. PCB specification, BOM and Schematic

5.1. ML62Q1577 Reference Board PCB specification

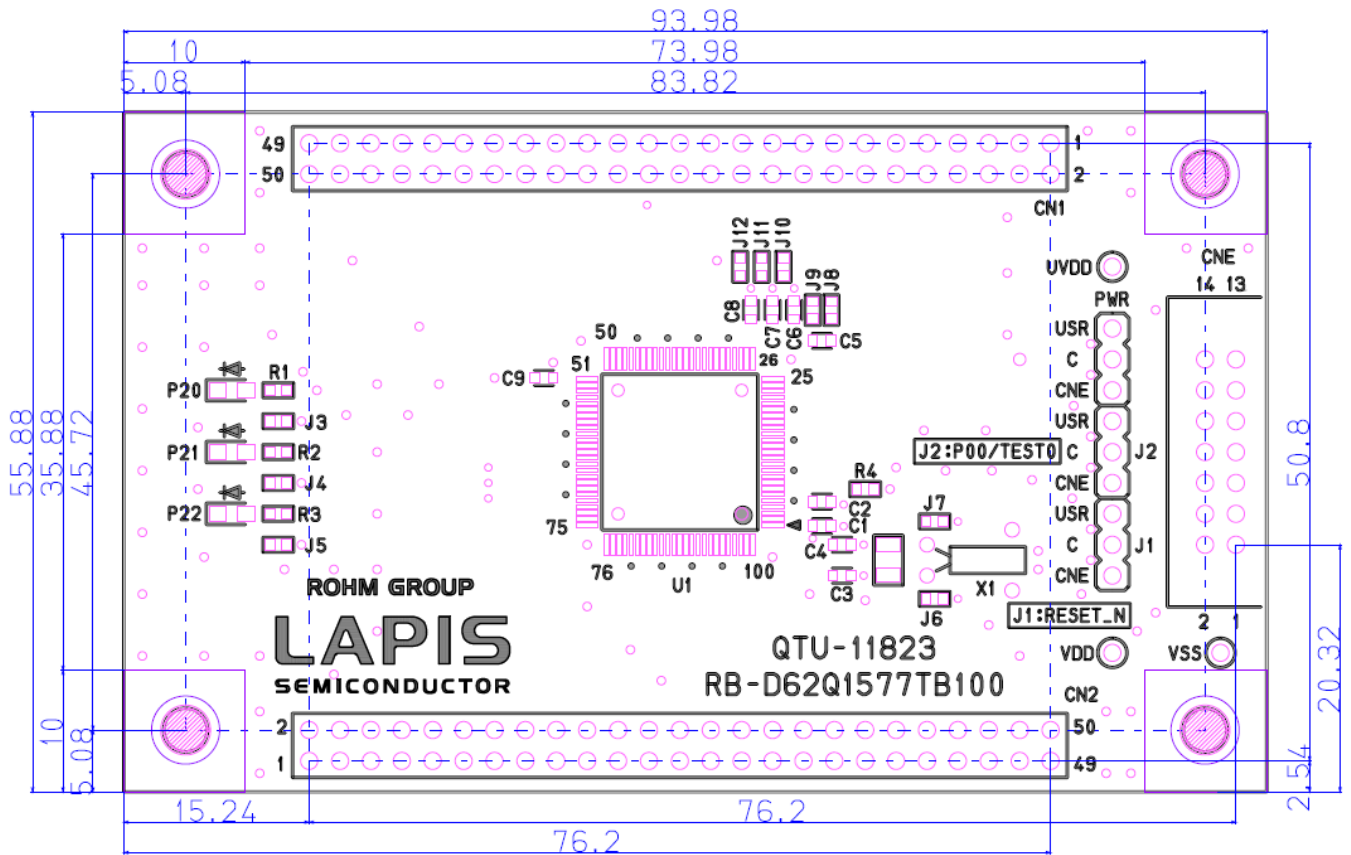


Fig. 7 shows the Reference Board PCB dimensional outline drawing and layout of components.

PCB part number:
RB-D62Q1577TB100

Dimension:
55.88mm x 93.98mm

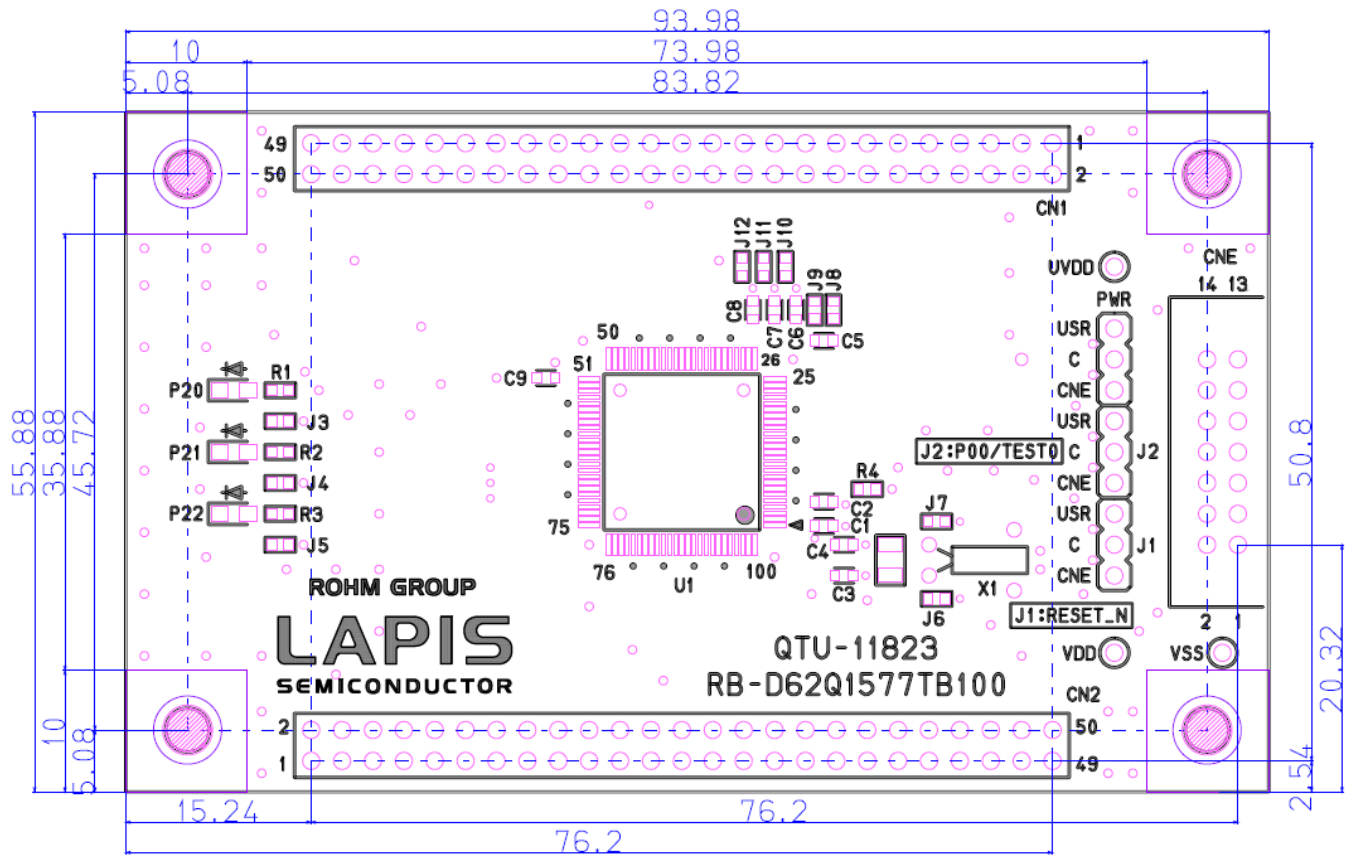


Fig. 7 Reference Board PCB dimensional outline drawing and layout of components (Top view)

5.2. ML62Q1577 Reference Board BOM

Table 3 Reference Board BOM

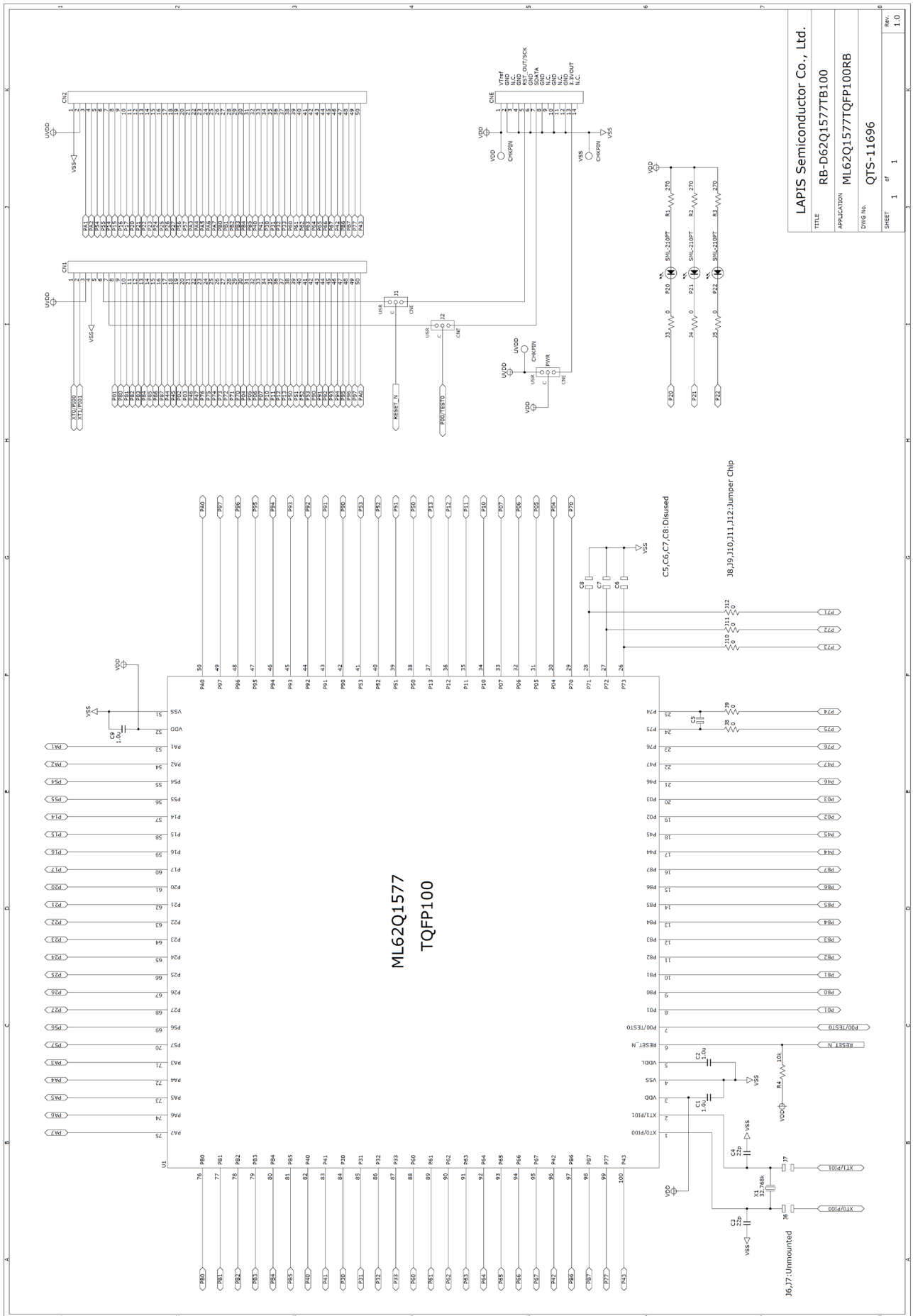
	Parts Number	Silk	Contents	Package Type	Qty.	Maker
1	QTU-11823-1	RB-D62Q1577TB100	PCB	-	1	LAPIS
2	ML62Q1577-xxxTB	U1	16-bit Microcontroller	TQFP100	1	LAPIS
3	GRM188R7YA105K	C1, C2, C9	Ceramic Capacitor 1uF/35V	1608(1.6x0.8mm)	3	MURATA
4	GRM1885C1H220J	C3, C4	Ceramic Capacitor 22pF/50V	1608(1.6x0.8mm)	2	MURATA
5	HIF3FC-14PA-2.54DSA(71)	CNE	14pin Header Connector	14PIN DIP	1	HIROSE
6	A2-3PA-2.54DSA	J1, J2, PWR	3pin Header Connector	3PIN DIP	3	HIROSE
7	MCR03ERTJ000	J3, J4, J5, J8, J9, J10, J11, J12	Resistor 0Ω	1608(1.6x0.8mm)	8	ROHM
8	SML-210PT	P20, P21, P22	LED Green	2012(2.0x1.2mm)	3	ROHM
9	MCR03EZPJ271	R1, R2, R3	Resistor 270Ω	1608(1.6x0.8mm)	3	ROHM
11	MCR03EZPJ103	R4	Resistor 10kΩ	1608(1.6x0.8mm)	1	ROHM
12	VT-200-F 12.5pF	X1	X'tal 32.768kHz 12.5pF	2PIN	1	SII
13	HIF3GA-2.54SP	-	Short pin	-	3	HIROSE
14	FF013-AR79	-	Rubber leg	-	4	KOYO FASTENER
15	P3555	-	Push rivet	-	4	KOYO FASTENER
16	-	C5, C6, C7, C8	Unmounted	1608(1.6x0.8mm)	3	-
17	-	CN1, CN2	Unmounted	50PIN DIP	2	-
18	-	J6, J7	Unmounted	1608(1.6x0.8mm)	2	-
19	-	VDD, VSS, UVDD	Unmounted	φ0.8mm	3	-

[Note]

- The diameter of through hole of CN1 and CN2 is 0.8 mm.
Using CN1 and CN2, the diameter of connector pin should use the connector below 0.8mm, such as 0.5mm.
- The parts may be changed into another parts with equivalent part special quality.

5.3. ML62Q1577 Reference Board Schematic

The next page shows the schematic of ML62Q1577 Reference Board



Revision History

Document No.	Issue Date	Page		Description
		Previous Edition	New Edition	
FEBL62Q1577RB-01	January 19, 2018	–	–	First edition.

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[RTK0EN0001D01001BZ](#) [MAXQ622-KIT#](#) [YR0K505231S000BE](#) [YR0K50571MS000BE](#) [YQB-R5F1057A-TB](#) [QB-R5F104PJ-TB](#) [CC-](#)
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